



APA600-BG456M

Part Number:	APA600-BG456M
Manufacturer/Brand:	Microsemi
Product description	IC FPGA 356 I/O 456BGA
Datasheets:	 APA600-BG456M.pdf
RoHs Status	 Contains lead / RoHS non-compliant
Ship From	Hong Kong
Shipment Way	DHL/Fedex/TNT/UPS/EMS

REQUEST FOR QUOTATION

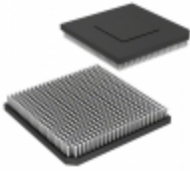
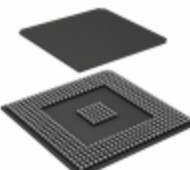
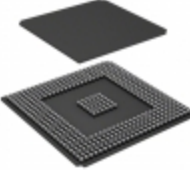
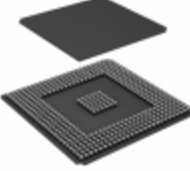
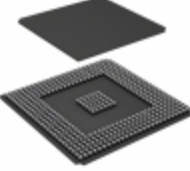
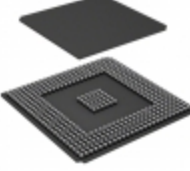
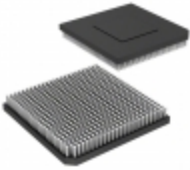
Specifications of APA600-BG456M

PART NUMBER	APA600-BG456M
MANUFACTURER	Microsemi
DESCRIPTION	IC FPGA 356 I/O 456BGA
LEAD FREE STATUS / ROHS STATUS	Contains lead / RoHS non-compliant
DATA SHEET	 APA600-BG456M.pdf
VOLTAGE - SUPPLY	2.3 V ~ 2.7 V
TOTAL RAM BITS	129024
SUPPLIER DEVICE PACKAGE	456-PBGA (35x35)
SERIES	ProASICPLUS
PACKAGE / CASE	456-BBGA
OPERATING TEMPERATURE	-55°C ~ 125°C (TC)
NUMBER OF I/O	356
NUMBER OF GATES	600000
MOUNTING TYPE	Surface Mount
MOISTURE SENSITIVITY LEVEL (MSL)	3 (168 Hours)
LEAD FREE STATUS / ROHS STATUS	Contains lead / RoHS non-compliant
BASE PART NUMBER	APA600

Related Tags

Microsemi APA600-BG456M	APA600-BG456M Distributor	APA600-BG456M Supplier
APA600-BG456M Price	APA600-BG456M Pictures	APA600-BG456M Image
APA600-BG456M PDF Datasheet	APA600-BG456M Download Datasheet	APA600-BG456M Datasheet
APA600-BG456M Stock	Buy APA600-BG456M	Buy Microsemi APA600-BG456M
Microsemi APA600-BG456M	Microsemi Supplier	Microsemi Distributor
Microsemi APA600-BG456M	Microsemi Analog Mixed Signal Group APA600-BG456M	Microsemi Analog Mixed Signal Group [MIL] APA600-BG456M
Microsemi Consumer Medical Product Group APA600-BG456M	Microsemi HI-REL [MIL] APA600-BG456M	Microsemi Power Management Group APA600-BG456M
Microsemi Power Products Group APA600-BG456M	Microsemi SoC APA600-BG456M	Microsemi Commercial Components Group APA600-BG456M
Microsemi Corporation APA600-BG456M	Microsemi Solutions Sdn Bhd. APA600-BG456M	

Related Products

 APA600-CGS624M Manufacturers: Microsemi Description: IC FPGA 440 I/O 624CCGA In stock: Out stock RFQ	 APA503-00-002 Manufacturers: Astec America (Artesyn Embedded Technologies) Description: STUD MTG SOLDER FOR HEATSINK In stock: Out stock RFQ
 APA600-BGG456I Manufacturers: Microsemi Description: IC FPGA 356 I/O 456BGA In stock: Out stock RFQ	 APA600-CQ208B Manufacturers: Microsemi Description: IC FPGA 158 I/O 208CQFP In stock: Out stock RFQ
 APA600-BGG456M Manufacturers: Microsemi Description: IC FPGA 356 I/O 456BGA In stock: Out stock RFQ	 APA504-00-001 Manufacturers: Astec America (Artesyn Embedded Technologies) Description: SOCKET SPRING(20-CONTROL/15-PWR) In stock: Out stock RFQ
 APA600-BGG456 Manufacturers: Microsemi Description: IC FPGA 356 I/O 456BGA In stock: Out stock RFQ	 APA600-BG456I Manufacturers: Microsemi Description: IC FPGA 356 I/O 456BGA In stock: Out stock RFQ
 APA600-BG456 Manufacturers: Microsemi Description: IC FPGA 356 I/O 456BGA In stock: Out stock RFQ	 APA503-00-008 Manufacturers: Astec America (Artesyn Embedded Technologies) Description: STUD MTG SOLDER FOR HEATSINK LP In stock: Out stock RFQ
 APA503-00-007 Manufacturers: Astec America (Artesyn Embedded Technologies) Description: STUD MTG TAPPED FOR HEATSINK LP In stock: Out stock RFQ	 APA600-CGS624B Manufacturers: Microsemi Description: IC FPGA 440 I/O 624CGA In stock: Out stock RFQ